

Revision History	
Revision	Notes

Orderable: <a href="#">N/A</a>	Designed for: <a href="#">Public Release</a>	Mod. Date: 06/29/2015
TID #: <a href="#">TIDC-CC3200 EPD DES</a>	Object Title: <a href="#">EPD Boosterpack</a>	
Number: <a href="#">EPD_BP</a>	Rev: <a href="#">E1</a>	Sheet Title:
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">[No Variations]</a>	Sheet: <a href="#">1</a> of <a href="#">3</a>
Drawn By:	File: <a href="#">CoverSheet.SchDoc</a>	Size: B
Engineer: <a href="#">Asaf Carmeli</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	 <b>TEXAS INSTRUMENTS</b> <a href="http://www.ti.com">http://www.ti.com</a>
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1 2 3 4 5 6

A

A

B

B

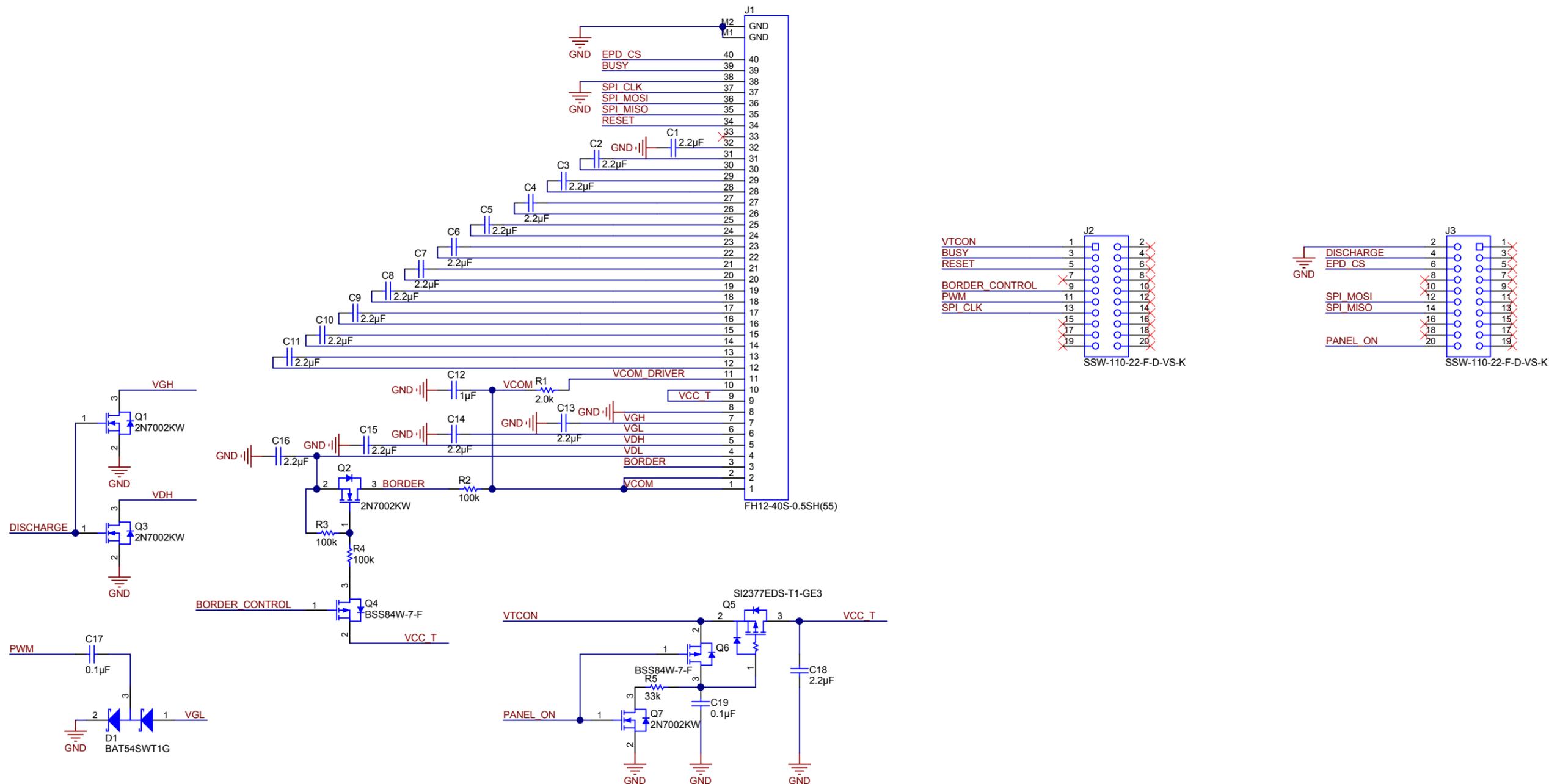
C

C

D

D

1 2 3 4 5 6



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Orderable: N/A	Designed for: Public Release	Mod. Date: 10/06/2016
TID #: TIDC-CC3200 EPD DES	Object Title: EPD Boosterpack	
Number: EPD_BP	Rev: E1	Sheet: 2 of 3
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Size: B
Drawn By:	File: EPD_BP_SchDoc	
Engineer: Asaf Carmeli	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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PCB Number: EPD\_BP  
PCB Rev: E1

EPD Boosterpack	
Variant	Description
001	Default assembly

ZZ1  
**Assembly Note**  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2  
**Assembly Note**  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3  
**Assembly Note**  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: N/A	Designed for: Public Release	Mod. Date: 06/29/2015
TID #: TIDC-CC3200 EPD DES	Object Title: EPD Boosterpack	
Number: EPD_BP	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 3 of 3
Drawn By:	File: TID_Hardware.SchDoc	Size: B
Engineer: Asaf Carmeli	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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